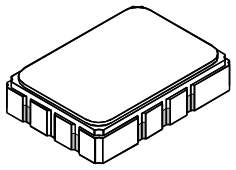
SF2039B

72.540 MHz
SAW Filter

- ***Designed for SDARS IF Receiver***
- ***Low Insertion Loss***
- ***5.0 X 7.0 mm Surface-Mount Case***
- ***Differential or Single Ended Input and Output***
- ***Complies with Directive 2002/95/EC (RoHS)***



SMP-03

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Max Soldering Profile	265°C for 10 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_C	1		72.540		MHz
Passband Insertion Loss	IL			10.5	12.5	dB
1dB Passband	BW_1	1	3.7	4.0		MHz
15dB Bandwidth	BW_{15}			6.5	6.7	MHz
30dB Bandwidth	BW_{30}			7.5	7.7	MHz
Amplitude Ripple over fc ±1.85 MHz				0.5	1.3	dB_{P-P}
Group Delay Variation over fc ±1.85 MHz	GDV			60	150	ns_{P-P}
Rejection 50 to 66.48 MHz		1, 3	40	47		dB
66.48 to 68.08 MHz			38	43		
77.30 to 78.60 MHz			38	42		
78.60 to 86.50 MHz			40	44		
86.50 to 91.50 MHz			45	50		
91.50 to 100.00 MHz			45	55		
Operating Temperature Range	T_A	1	-40		+85	°C
Frequency Temperature Coefficient	FTC			-18		ppm/°C
Differential Input	175 ohms					
Differential Output	1000 ohms					
Case Style		6	SMP-03 7 x 5 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift) See note 4			RFM SF2039B YYWWS			

Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others

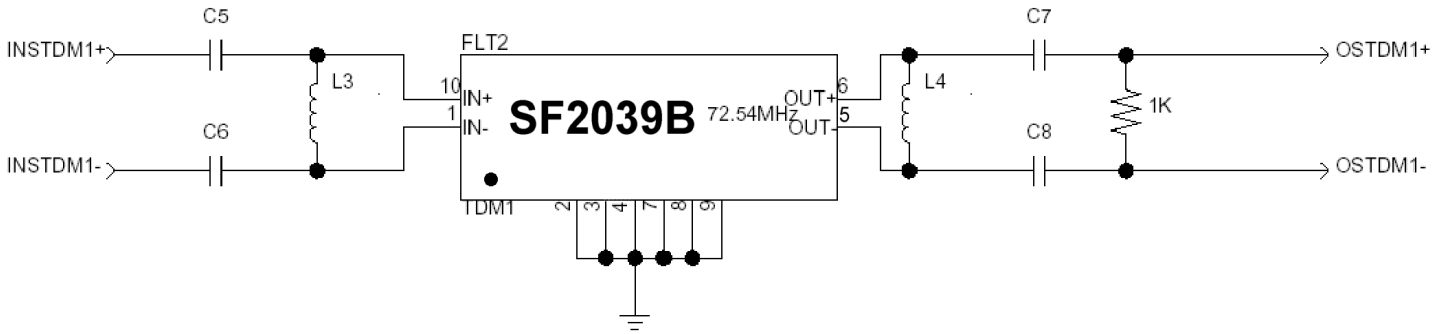
Notes:
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
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11. Electrostatic Sensitive Device. Observe precautions for handling.

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Matching Circuit and Matching Component Values Used in G3 Sirius Radios

(Refer to Sirius Radio G3 Chipset Application Note, Doc. #RX000104-B, Sec. 4.2.3)



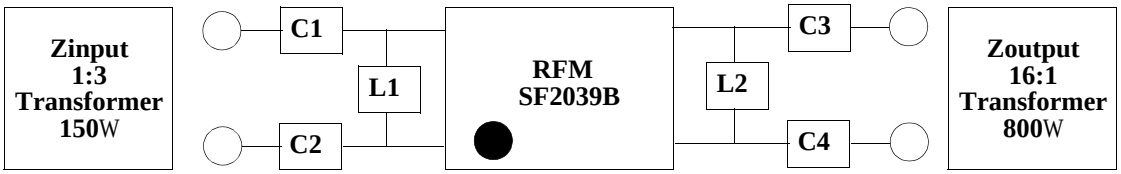
TDM1 Narrowband SAW Matching Circuit

TDM1 Narrowband SAW Matching Values

Reference Designator	Value
C5	10 pF
C6	10 pF
L3	330 nH
L4	560 nH
C7	100 pF
C8	100 pF

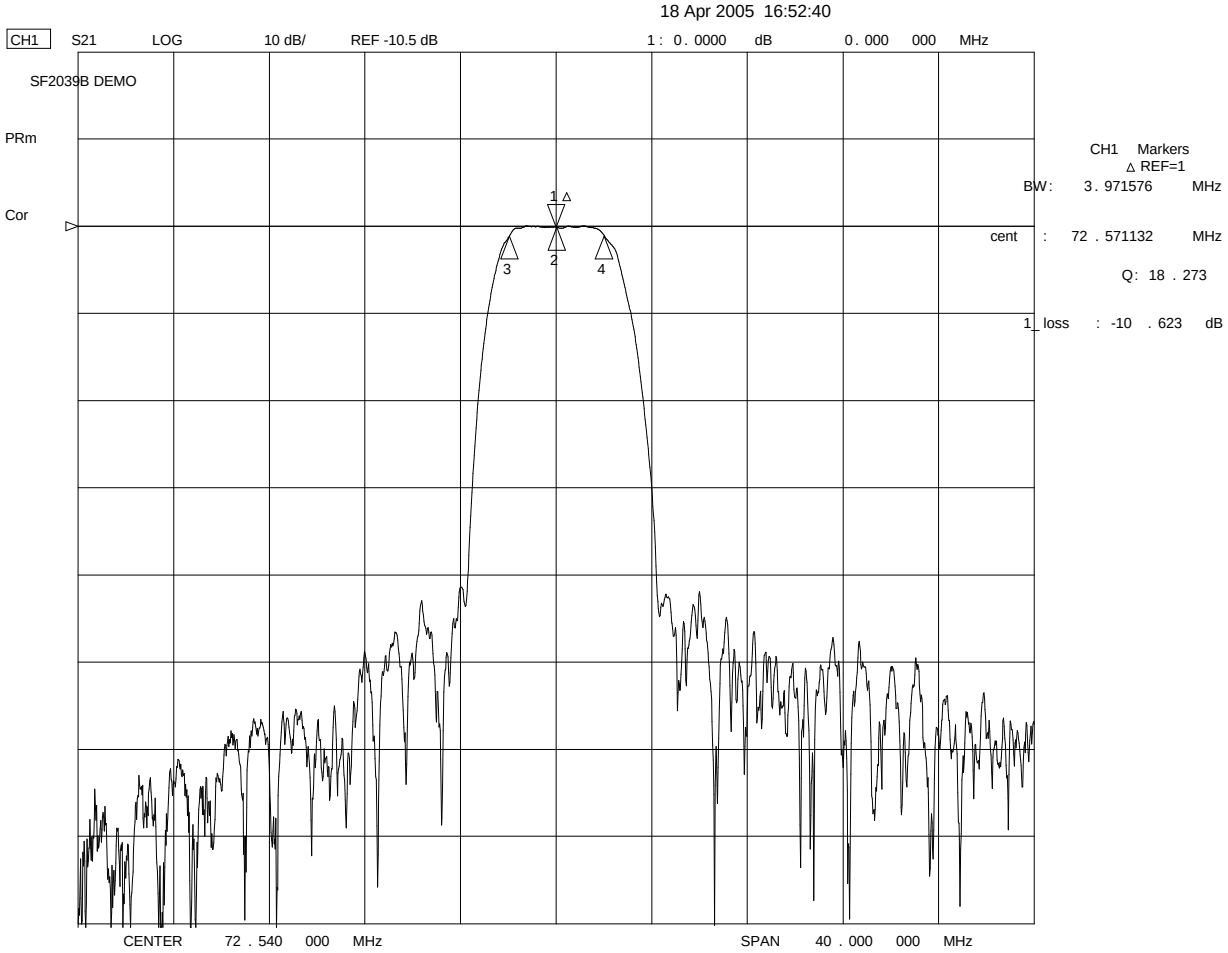
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Matching Circuit and Matching Component Values Used on Filter Demo Board

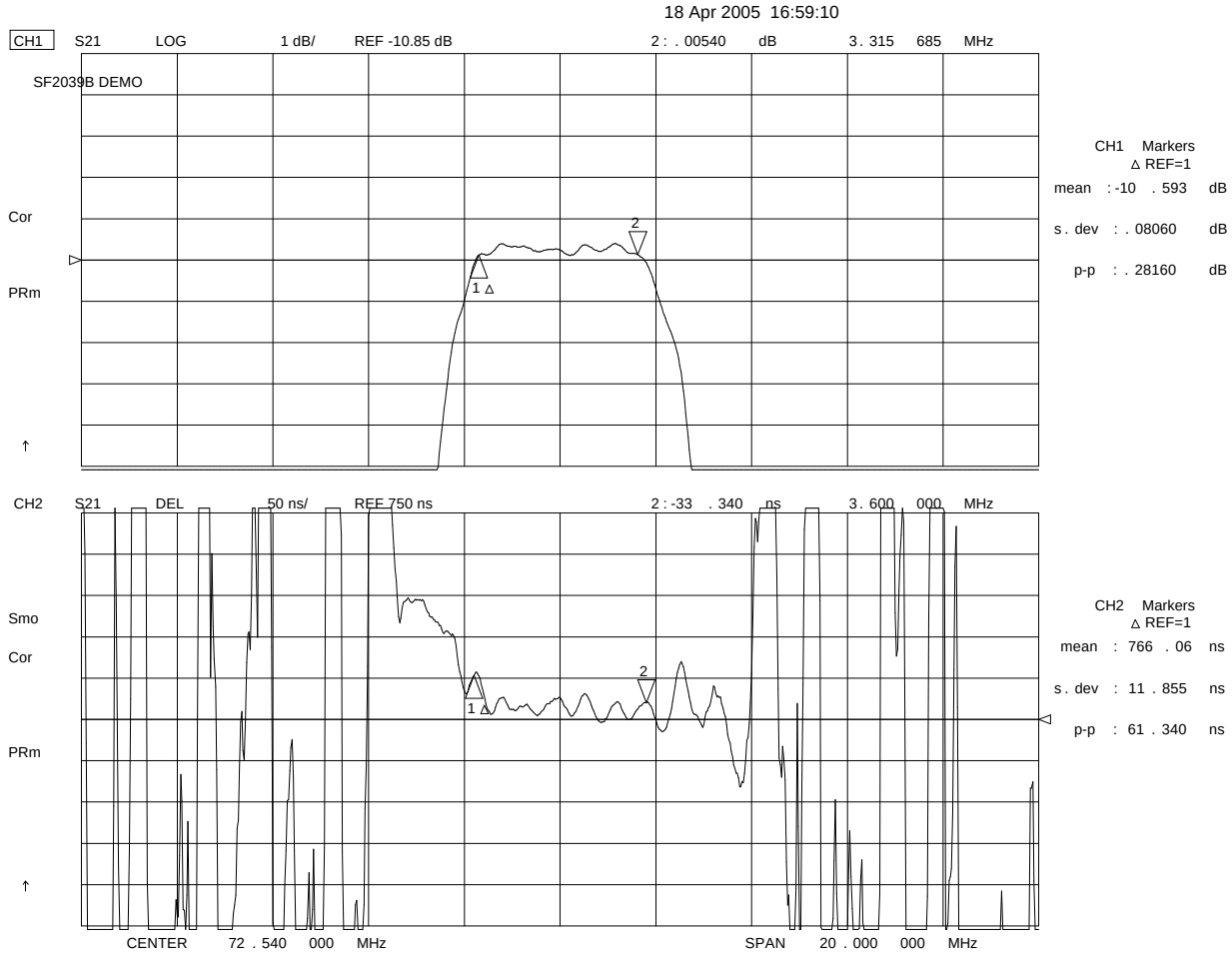


SF2039B
72.540 MHz

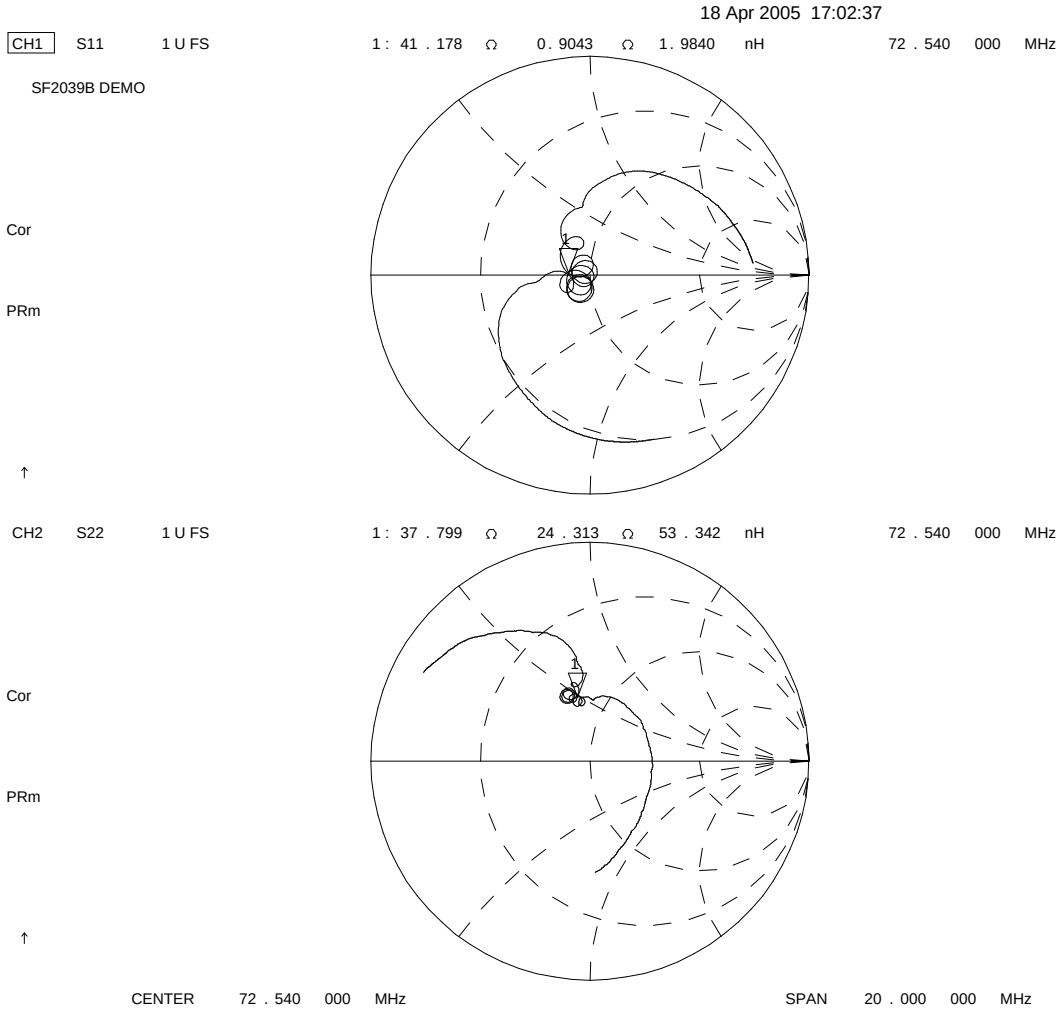
C1 = 10pF
C2 = 10pF
L1 = 330nH
L2 = 390nH
C3 = 18pF
C4 = 18pF



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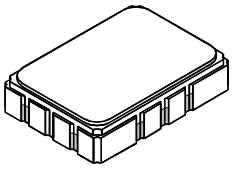
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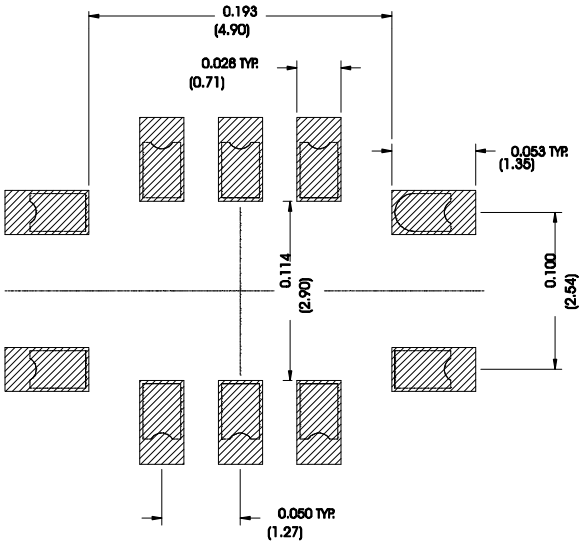
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SMP-03 Case

10-Terminal Ceramic Surface-Mount Case
7 x 5 mm Nominal Footprint



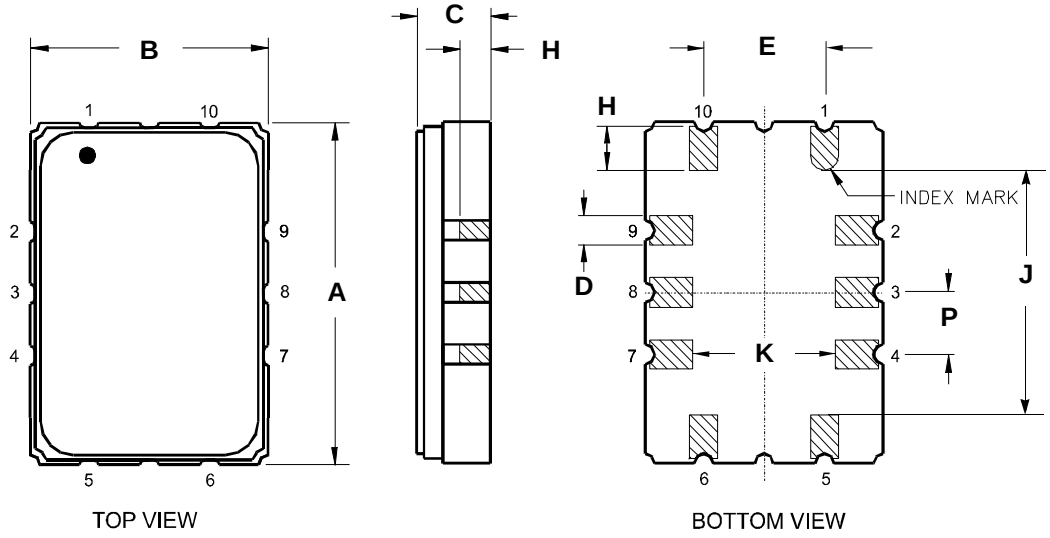
Recommended PCB Footprint



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

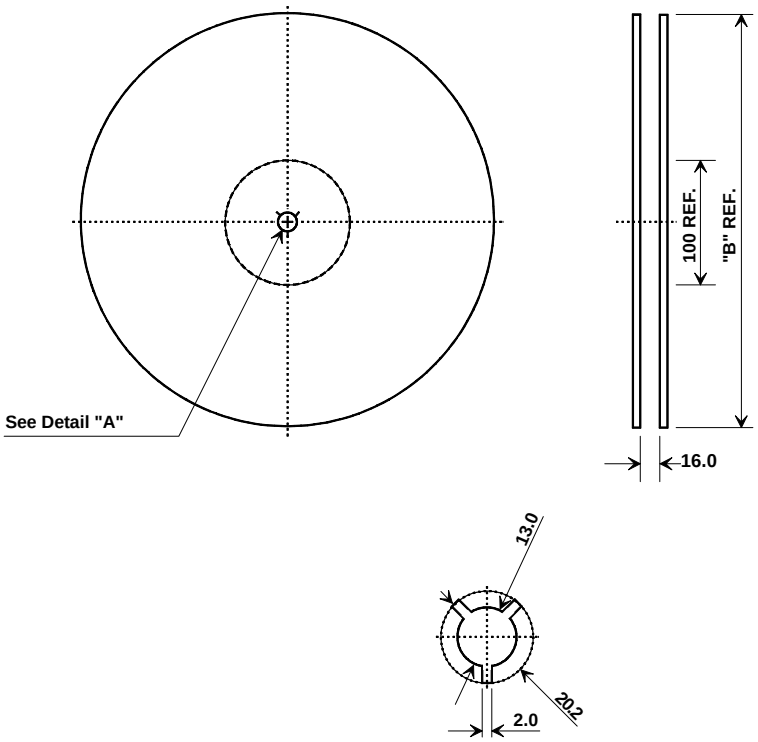
Materials	
Solder Pad Termination	Au plating 30 - 60 uInches (76.2-152 uM) over 80-200 uInches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 uInches Thick
Body	Al_2O_3 Ceramic
Pb Free	

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		**Return is ground**
Differential Operation		**Return is hot**



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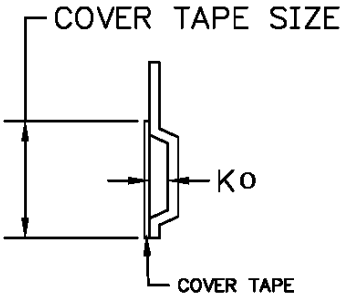
Tape and Reel Specifications

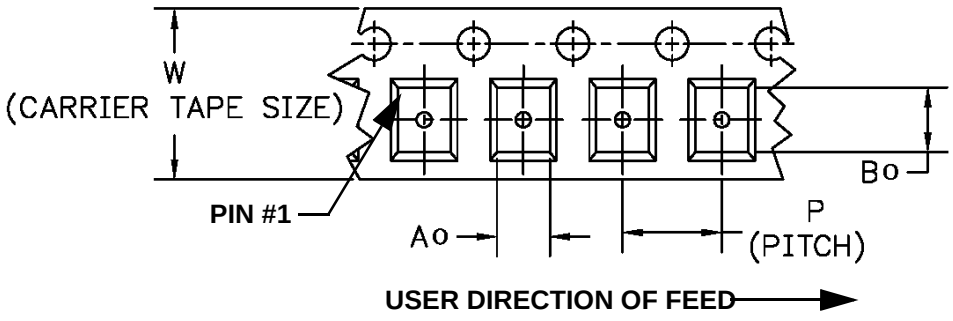


"B " Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm





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